Simple technologies for fabrication of low-loss silica waveguides

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SILICA TECHNOLOGIES FOR FABRICATION OF FABRICATION OF LOW-LOSS SILICA WAVEGUIDES


Introduction: Silica-based optical waveguides have received much attention in recent years in guided-wave optical circuits owing to the advantages of low-cost, low propagation loss, hybrid optical packaging and good match to optical fibres [1-2]. A variety of circuits and components based on silica waveguides have been developed by AT&T Bell Laboratories and NTT Opto-Electronics Laboratories [3-7]. Most published work on silica waveguides refers to two technologies: the Si/SiO/SiNx/SiO, and the Si/SiO, doped SiO/SiO, multilayer waveguides [1-2]. Whereas the silica waveguides with SiNx as guiding layer have large refractive index contrast (≈0.5) and are suitable for matching to semiconductors, waveguides with doped SiO, as guiding layer have small index contrast (≈5 x 10^-2) and are suitable for matching to optical fibres.

We propose a PECVD-based technology which uses only N, and SiH, to form the SiO, guiding layer. The refractive index profile of the guiding layer is controlled by the SiH, flow rate during deposition. There are two advantages in using this technique. First, the use of poisonous gas such as PH, and GeH, for the doping of the SiO, is avoided in the process. There are hazards in the use of silane. Secondly, the refractive index contrast in using this technology can be varied from 5 x 10^-3 to 0.5. The waveguide design is therefore very flexible to meeting different requirements for the refractive index and optical field profiles.

Waveguide fabrication and loss measurements: SiO, can be formed with plasma enhanced chemical vapour deposition (PECVD) using the following chemical reaction:

\[
\text{SiH}_4 + 2\text{N}_2\text{O} \rightarrow \text{SiO}_2 + 2\text{N}_2 + 2\text{H}_2
\]

It is found that by controlling the flow ratio of SiH, and N, in the PECVD the structure of the deposited SiO, layer can be changed to SiO, This change will affect the refractive index of the deposited layer. The change of the refractive index is proportional to the SiH, /N, flow ratio.

Fig. 1 shows the dependence of the refractive index of the deposited layers on the ratio SiH, /N, as measured with an ellipsometer at a wavelength of 0.6328 μm. A refractive index of n = 1.46 is achieved for ratios SiH, /N, < 0.025. From the Figure it is seen that the refractive index of the deposited layers varies linearly with the SiH, flow.

Silica waveguides based on this technology were fabricated as follows. First, a 9 μm thick SiO, is obtained by thermal oxidation of the Si substrate. The guiding layer is then formed by depositing an SiO, layer with PECVD. The core ribs are formed by wet etching the guiding layer with BHF at room temperature. Finally, the processed wafer is covered with a PECVD SiO, layer. The inset of Fig. 3 shows a cross-section of the waveguide structure.

The etch rate of the deposited SiO, layer with BHF is dependent on its composition. Fig. 2 shows the dependence of the etching rate from the SiH, /N, flow ratio. It is seen that oxygen content reduces the etch rate.

The propagation losses of the waveguides were measured by the cut-back method. The light beam from a 1.3 μm semiconductor laser was coupled into the front facets of the waveguides by means of a × 20/0.45 microscope objective. The losses of the waveguides were determined by measuring the light intensities at the output facets of the waveguides. The measured propagation losses of the waveguides are of the order of 0.2 dB/cm. Because optical absorption associated with OH- in the deposited layers contributes to the loss, it can be reduced by annealing the waveguides at a high temperature. After annealing at a temperature of 1100°C for 30 min in an N, atmosphere, the propagation losses are reduced to <0.1 dB/cm. The propagation losses of the waveguides after 30 min annealing at different temperature are shown in Fig. 3.

Conclusions: The technology for fabrication of silica waveguides presented in this Letter is simple and reproducible. Use of poisonous gases is avoided. Waveguides with propagation losses less than 0.1 dB/cm are obtained. By controlling the flow ratio of SiH, /N, in the PECVD, the refractive index contrast can be varied between 5 x 10^-3 and 0.5, so that the waveguides can be designed to match to either optical fibres or photonic devices based on III-V compound semiconductors.

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VERY HIGH SIDEMODE SUPPRESSION-RATIO DISTRIBUTED-BRAGG-REFLECTOR LASERS GROWN BY CHEMICAL BEAM EPITAXY


Indexing terms: Lasers, Semiconductor lasers

The fabrication and performance of InGaAs/GaAsP multiquantum well distributed-Bragg-reflector lasers grown by chemical beam epitaxy are reported. The growth advantages of uniformity and well controlled thickness by CBE, we report the fabrication of DBR lasers with a record high SMSR of 58.5dB.

FIG. 1 Growth layer structure of DBR laser

InP buffer layer, a 1.25 \( \mu \)m wavelength InGaAsP (1.25 Q) waveguide layer with 2700 \( \AA \) thickness is grown. Following growth of a thin InP etch stop layer, a 250 \( \AA \) thick 1.25 Q grating layer and another InP etch stop layer are grown. The multiquantum well (MQW) gain medium is composed of six 50 \( \AA \) thick InGaAs strained quantum wells and six 120 \( \AA \) 1.25 Q barriers. Finally, a p-type InP protection layer is grown on the top layer.

The grown wafer is processed by a wet etching technique to remove the gain medium in the passive side. A holographic grating pattern is then generated and transferred to the grating layer through selective etching. Because the thickness of the grating layer is well controlled by the CBE growth time, the grating coupling constant \( \kappa \) is also well defined. Followed by stripe etching and semi-insulating and p-cap layer regrowth, the wafer is further processed for multi-electrode metallisation. The lasers are cleaved with a gain section \( \sim 225 \mu \)m long and a grating section \( \sim 360 \mu \)m long.

The fabricated lasers have thresholds of \( \sim 20 \)mA. The tuning range is 21 A. The short tuning range may partly be caused by a reduction of current tuning effect caused by the ‘counter wavelength shift’ by heat generation in such a long grating section. However, each laser can be easily tuned to its Bragg band centre to obtain better mode behaviour.

FIG. 2 L-I and I-V curves of one of the DBR lasers

Inset: output spectrum of laser at 87 mA bias

- \( L_{\text{center}} = 355 \mu \)m
- \( L_{\text{peak}} = 360 \mu \)m
- \( I_{d} = 19 \)mA

The CW biased light-current (L-I) curve and current-voltage (I-V) curve of a laser and its SMSR at a bias of 87 mA. A record high SMSR of 58.5dB has been achieved with these lasers. For most of the lasers, 10mW output can be easily achieved and the measured output linewidths are below 10 MHz which is attributed to the effect of the narrow Bragg bandwidth produced by the long and weak waveguide grating.

The theoretically calculated \( \kappa \) of the laser structure employing...